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Peripherals	Brown-out Detect/Reset, LVD, Motor Control PWM, QEI, POR, PWM, WDT
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Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
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Supplier Device Package	80-TQFP (12x12)
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dsPIC30F6010A/6015

High-Performance, 16-bit Digital Signal Controllers

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046). For more information on the device instruction set and programming, refer to the *"16-bit MCU and DSC Programmer's Reference Manual"* (DS70157).

High-Performance Modified RISC CPU:

- Modified Harvard architecture
- C compiler optimized instruction set architecture with flexible Addressing modes
- 83 base instructions
- 24-bit wide instructions, 16-bit wide data path
- 144 Kbytes on-chip Flash program space (Instruction words)
- 8 Kbytes of on-chip data RAM
- 4 Kbytes of nonvolatile data EEPROM
- Up to 30 MIPS operation:
  - DC to 40 MHz external clock input
  - 4 MHz-10 MHz oscillator input with PLL active (4x, 8x, 16x)
  - 7.37 MHz internal RC with PLL active (4x, 8x, 16x)
- 44 interrupt sources:
  - Five external interrupt sources
  - Eight user selectable priority levels for each interrupt source
  - Four processor trap sources
- 16 x 16-bit working register array

DSP Engine Features:

- Dual data fetch
- Accumulator write-back for DSP operations
- Modulo and Bit-Reversed Addressing modes
- Two, 40-bit wide accumulators with optional saturation logic
- 17-bit x 17-bit single-cycle hardware fractional/ integer multiplier
- All DSP instructions single cycle
- ±16-bit single-cycle shift

Peripheral Features:

- High-current sink/source I/O pins: 25 mA/25 mA
- Timer module with programmable prescaler:
  - Five 16-bit timers/counters; optionally pair 16-bit timers into 32-bit timer modules
- 16-bit Capture input functions
- 16-bit Compare/PWM output functions
- 3-wire SPI modules (supports 4 Frame modes)
- I^2C™ module supports Multi-Master/Slave mode and 7-bit/10-bit addressing
- Two UART modules with FIFO Buffers
- Two CAN modules, 2.0B compliant (dsPIC306010A)
- One CAN module, 2.0B compliant (dsPIC306015)

Motor Control PWM Module Features:

- Eight PWM output channels:
  - Complementary or Independent Output modes
  - Edge and Center-Aligned modes
- Four duty cycle generators
- Dedicated time base
- Programmable output polarity
- Dead-Time control for Complementary mode
- Manual output control
- Trigger for A/D conversions

Quadrature Encoder Interface Module Features:

- Phase A, Phase B and Index Pulse input
- 16-bit up/down position counter
- Count direction status
- Position Measurement (x2 and x4) mode
- Programmable digital noise filters on inputs
- Alternate 16-bit Timer/Counter mode
- Interrupt on position counter rollover/underflow

Analog Features:

- 10-bit Analog-to-Digital Converter (ADC) with four S/H Inputs:
  - 1 Msps conversion rate
  - 16 input channels
  - Conversion available during Sleep and Idle
- Programmable Brown-out Reset

Special Microcontroller Features:

- Enhanced Flash program memory:
  - 10,000 erase/write cycle (min.) for industrial temperature range, 100K (typical)
- Data EEPROM memory:
  - 100,000 erase/write cycle (min.) for industrial temperature range, 1M (typical)
- Self-reprogrammable under software control
- Power-on Reset (POR), Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Flexible Watchdog Timer (WDT) with on-chip, low-power RC oscillator for reliable operation
- Fail-Safe Clock Monitor operation detects clock failure and switches to on-chip, low-power RC oscillator
- Programmable code protection
- In-Circuit Serial Programming™ (ICSP™)
- Selectable Power Management modes
  - Sleep, Idle and Alternate Clock modes

CMOS Technology:

- Low-power, high-speed Flash technology
- Wide operating voltage range (2.5V to 5.5V)
- Industrial and Extended temperature ranges
- Low-power consumption

dsPIC30F Motor Control and Power Conversion Family

Device	Pins	Program Mem. Bytes/ Instructions	SRAM Bytes	EEPROM Bytes	Timer 16-bit	Input Cap	Output Comp/Std PWM	Motor Control PWM	A/D 10-bit 1 Msps	Quad Enc	UART	SPI	I²C™	CAN
dsPIC30F6010A	80	144K/48K	8192	4096	5	8	8	8 ch	16 ch	Yes	2	2	1	2
dsPIC30F6015	64	144K/48K	8192	4096	5	8	8	8 ch	16 ch	Yes	2	2	1	1

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NOTES:

The SA and SB bits are modified each time data passes through the adder/subtractor, but can only be cleared by the user. When set, they indicate that the accumulator has overflowed its maximum range (bit 31 for 32-bit saturation, or bit 39 for 40-bit saturation) and will be saturated if saturation is enabled. When saturation is not enabled, SA and SB default to bit 39 overflow and thus indicate that a catastrophic overflow has occurred. If the COVTE bit in the INTCON1 register is set, SA and SB bits will generate an arithmetic warning trap when saturation is disabled.

The Overflow and Saturation Status bits can optionally be viewed in the STATUS register (SR) as the logical OR of OA and OB (in bit OAB) and the logical OR of SA and SB (in bit SAB). This allows programmers to check one bit in the STATUS register to determine if either accumulator has overflowed, or one bit to determine if either accumulator has saturated. This would be useful for complex number arithmetic which typically uses both the accumulators.

The device supports three Saturation and Overflow modes.

1. Bit 39 Overflow and Saturation:
   When bit 39 overflow and saturation occurs, the saturation logic loads the maximally positive 9.31 (0x7FFFFFFFFF) or maximally negative 9.31 value (0x8000000000) into the target accumulator. The SA or SB bit is set and remains set until cleared by the user. This is referred to as 'super saturation' and provides protection against erroneous data or unexpected algorithm problems (e.g., gain calculations).
2. Bit 31 Overflow and Saturation:
   When bit 31 overflow and saturation occurs, the saturation logic then loads the maximally positive 1.31 value (0x007FFFFFFF) or maximally negative 1.31 value (0x0080000000) into the target accumulator. The SA or SB bit is set and remains set until cleared by the user. When this Saturation mode is in effect, the guard bits are not used so the OA, OB or OAB bits are never set.
3. Bit 39 Catastrophic Overflow
   The bit 39 Overflow Status bit from the adder is used to set the SA or SB bit, which remain set until cleared by the user. No saturation operation is performed and the accumulator is allowed to overflow (destroying its sign). If the COVTE bit in the INTCON1 register is set, a catastrophic overflow can initiate a trap exception.

2.4.2.2 Accumulator 'Write-Back'

The MAC class of instructions (with the exception of MPY, MPY.N, ED and EDAC) can optionally write a rounded version of the high word (bits 31 through 16) of the accumulator that is not targeted by the instruction into data space memory. The write is performed across the X bus into combined X and Y address space. The following addressing modes are supported:

1. W13, Register Direct:
   The rounded contents of the non-target accumulator are written into W13 as a 1.15 fraction.
2. [W13]+ = 2, Register Indirect with Post-Increment:
   The rounded contents of the non-target accumulator are written into the address pointed to by W13 as a 1.15 fraction. W13 is then incremented by 2 (for a word write).

2.4.2.3 Round Logic

The round logic is a combinational block, which performs a conventional (biased) or convergent (unbiased) round function during an accumulator write (store). The Round mode is determined by the state of the RND bit in the CORCON register. It generates a 16-bit, 1.15 data value which is passed to the data space write saturation logic. If rounding is not indicated by the instruction, a truncated 1.15 data value is stored and the least significant word is simply discarded.

Conventional rounding takes bit 15 of the accumulator, zero-extends it and adds it to the ACCxH word (bits 16 through 31 of the accumulator). If the ACCxL word (bits 0 through 15 of the accumulator) is between 0x8000 and 0xFFFF (0x8000 included), ACCxH is incremented. If ACCxL is between 0x0000 and 0x7FFF, ACCxH is left unchanged. A consequence of this algorithm is that over a succession of random rounding operations, the value will tend to be biased slightly positive.

Convergent (or unbiased) rounding operates in the same manner as conventional rounding, except when ACCxL equals 0x8000. If this is the case, the LSb (bit 16 of the accumulator) of ACCxH is examined. If it is '1', ACCxH is incremented. If it is '0', ACCxH is not modified. Assuming that bit 16 is effectively random in nature, this scheme will remove any rounding bias that may accumulate.

The SAC and SAC.R instructions store either a truncated (SAC) or rounded (SAC.R) version of the contents of the target accumulator to data memory, via the X bus (subject to data saturation, see **Section 2.4.2.4 "Data Space Write Saturation"**). Note that for the MAC class of instructions, the accumulator write-back operation will function in the same manner, addressing combined MCU (X and Y) data space though the X bus. For this class of instructions, the data is always subject to rounding.

3.0 MEMORY ORGANIZATION

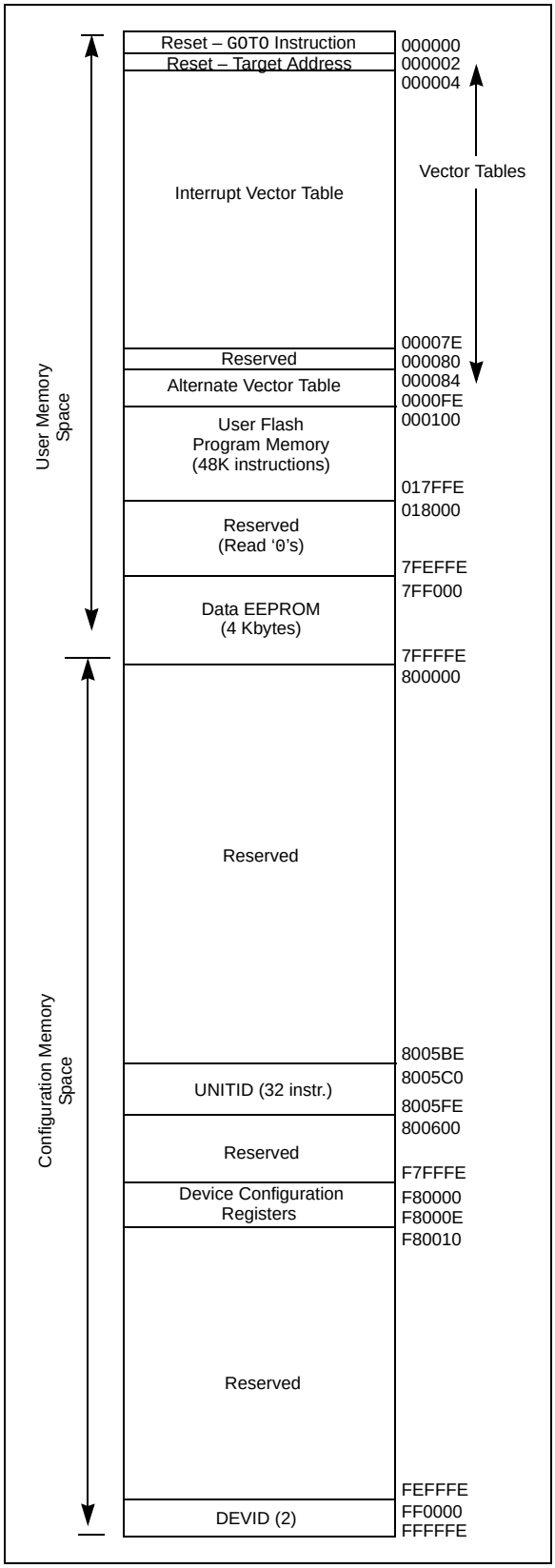
Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046). For more information on the device instruction set and programming, refer to the *"16-bit MCU and DSC Programmer's Reference Manual"* (DS70157).

3.1 Program Address Space

The program address space is 4M instruction words. It is addressable by the 23-bit PC, table instruction Effective Address (EA), or data space EA, when program space is mapped into data space, as defined by Table 3-1. Note that the program space address is incremented by two between successive program words, in order to provide compatibility with data space addressing.

User program space access is restricted to the lower 4M instruction word address range (0x000000 to 0x7FFFFE), for all accesses other than TBLRD/TBLWT, which use TBLPAG<7> to determine user or configuration space access. In Table 3-1, read/write instructions, bit 23 allows access to the device ID, the user ID and the Configuration bits. Otherwise, bit 23 is always clear.

FIGURE 3-1: PROGRAM SPACE MEMORY MAP FOR dsPIC30F6010A/6015



5.1 Interrupt Priority

The user-assignable Interrupt Priority bits (IP<2:0>) for each individual interrupt source are located in the Least Significant 3 bits of each nibble within the IPCx register(s). Bit 3 of each nibble is not used and is read as a '0'. These bits define the priority level assigned to a particular interrupt by the user.

Note: The user-assignable priority levels start at 0, as the lowest priority and level 7, as the highest priority.

Since more than one interrupt request source may be assigned to a specific user-assigned priority level, a means is provided to assign priority within a given level. This method is called "Natural Order Priority".

Natural Order Priority is determined by the position of an interrupt in the vector table, and only affects interrupt operation when multiple interrupts with the same user-assigned priority become pending at the same time.

Table 5-1 lists the interrupt numbers and interrupt sources for the dsPIC DSC devices and their associated vector numbers.

Note 1: The Natural Order Priority scheme has 0 as the highest priority and 53 as the lowest priority.

2: The Natural Order Priority number is the same as the INT number.

The ability for the user to assign every interrupt to one of seven priority levels means that the user can assign a very high overall priority level to an interrupt with a low natural order priority.

TABLE 5-1: INTERRUPT VECTOR TABLE

INT Number	Vector Number	Interrupt Source
Highest Natural Order Priority		
0	8	INT0 – External Interrupt 0
1	9	IC1 – Input Capture 1
2	10	OC1 – Output Compare 1
3	11	T1 – Timer1
4	12	IC2 – Input Capture 2
5	13	OC2 – Output Compare 2
6	14	T2 – Timer2
7	15	T3 – Timer3
8	16	SPI1
9	17	U1RX – UART1 Receiver
10	18	U1TX – UART1 Transmitter
11	19	ADC – ADC Convert Done
12	20	NVM - NVM Write Complete
13	21	SI2C – I^2C™ Slave Interrupt
14	22	MI2C – I^2C Master Interrupt
15	23	Input Change Interrupt
16	24	INT1 – External Interrupt 1
17	25	IC7 – Input Capture 7
18	26	IC8 – Input Capture 8
19	27	OC3 – Output Compare 3
20	28	OC4 – Output Compare 4
21	29	T4 – Timer4
22	30	T5 – Timer5
23	31	INT2 – External Interrupt 2
24	32	U2RX – UART2 Receiver
25	33	U2TX – UART2 Transmitter
26	34	SPI2
27	35	C1 – Combined IRQ for CAN1
28	36	IC3 – Input Capture 3
29	37	IC4 – Input Capture 4
30	38	IC5 – Input Capture 5
31	39	IC6 – Input Capture 6
32	40	OC5 – Output Compare 5
33	41	OC6 – Output Compare 6
34	42	OC7 – Output Compare 7
35	43	OC8 – Output Compare 8
36	44	INT3 – External Interrupt 3
37	45	INT4 - External Interrupt 4
38	46	C2 – Combined IRQ for CAN2
39	47	PWM – PWM Period Match
40	48	QEI – QEI Interrupt
41	49	Reserved
42	50	Reserved
43	51	$\overline{\text{FLTA}}$ – PWM Fault A
44	52	$\overline{\text{FLTB}}$ – PWM Fault B
45-53	53-61	Reserved
Lowest Natural Order Priority		

6.6 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. A programming operation is nominally 2 msec in duration and the processor stalls (waits) until the operation is finished. Setting the WR bit (NVMCON<15>) starts the operation, and the WR bit is automatically cleared when the operation is finished.

6.6.1 PROGRAMMING ALGORITHM FOR PROGRAM FLASH

The user can erase or program one row of program Flash memory at a time. The general process is:

1. Read one row of program Flash (32 instruction words) and store into data RAM as a data “image”.
2. Update the data image with the desired new data.
3. Erase program Flash row.
   a) Set up NVMCON register for multi-word, program Flash, erase, and set WREN bit.
   b) Write address of row to be erased into NVMADRU/NVMDR.
   c) Write 0x55 to NVMKEY.
   d) Write 0xAA to NVMKEY.
   e) Set the WR bit. This will begin erase cycle.
   f) CPU will stall for the duration of the erase cycle.
   g) The WR bit is cleared when erase cycle ends.
4. Write 32 instruction words of data from data RAM “image” into the program Flash write latches.
5. Program 32 instruction words into program Flash.
   a) Set up NVMCON register for multi-word, program Flash, program, and set WREN bit.
   b) Write 0x55 to NVMKEY.
   c) Write 0xAA to NVMKEY.
   d) Set the WR bit. This will begin program cycle.
   e) CPU will stall for duration of the program cycle.
   f) The WR bit is cleared by the hardware when program cycle ends.
6. Repeat steps 1 through 5 as needed to program desired amount of program Flash memory.

6.6.2 ERASING A ROW OF PROGRAM MEMORY

Example 6-1 shows a code sequence that can be used to erase a row (32 instructions) of program memory.

EXAMPLE 6-1: ERASING A ROW OF PROGRAM MEMORY

```
; Setup NVMCON for erase operation, multi word write
; program memory selected, and writes enabled
       MOV     #0x4041,W0                  ;
       MOV     W0,NVMCON                   ; Init NVMCON SFR
; Init pointer to row to be ERASED
       MOV     #tblpage(PROG_ADDR),W0      ;
       MOV     W0,NVMADRU                  ; Initialize PM Page Boundary SFR
       MOV     #tbloffset(PROG_ADDR),W0    ; Intialize in-page EA[15:0] pointer
       MOV     W0, NVMADR                  ; Intialize NVMADR SFR
       DISI    #5                          ; Block all interrupts with priority <7
                                           ; for next 5 instructions
       MOV     #0x55,W0
       MOV     W0,NVMKEY                   ; Write the 0x55 key
       MOV     #0xAA,W1                    ;
       MOV     W1,NVMKEY                   ; Write the 0xAA key
       BSET    NVMCON,#WR                  ; Start the erase sequence
       NOP                                 ; Insert two NOPs after the erase
       NOP                                 ; command is asserted
```

7.3.2 WRITING A BLOCK OF DATA EEPROM

To write a block of data EEPROM, write to all sixteen latches first, then set the NVMCON register and program the block.

EXAMPLE 7-5: DATA EEPROM BLOCK WRITE

```
    MOV        #LOW_ADDR_WORD,W0  ; Init pointer
    MOV        #HIGH_ADDR_WORD,W1
    MOV        W1,TBLPAG
    MOV        #data1,W2          ; Get 1st data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data2,W2          ; Get 2nd data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data3,W2          ; Get 3rd data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data4,W2          ; Get 4th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data5,W2          ; Get 5th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data6,W2          ; Get 6th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data7,W2          ; Get 7th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data8,W2          ; Get 8th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data9,W2          ; Get 9th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data10,W2         ; Get 10th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data11,W2         ; Get 11th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data12,W2         ; Get 12th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data13,W2         ; Get 13th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data14,W2         ; Get 14th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data15,W2         ; Get 15th data
    TBLWTL     W2,[W0]++          ; write data
    MOV        #data16,W2         ; Get 16th data
    TBLWTL     W2,[W0]++          ; write data. The NVMADR captures last table access address.
    MOV        #0x400A,W0         ; Select data EEPROM for multi word op
    MOV        W0,NVMCON          ; Operate Key to allow program operation
    DISI       #5                 ; Block all interrupts with priority <7
                                  ; for next 5 instructions
    MOV        #0x55,W0
    MOV        W0,NVMKEY          ; Write the 0x55 key
    MOV        #0xAA,W1
    MOV        W1,NVMKEY          ; Write the 0xAA key
    BSET       NVMCON,#WR         ; Start write cycle
    NOP
    NOP
```

7.4 Write Verify

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

7.5 Protection Against Spurious Write

There are conditions when the device may not want to write to the data EEPROM memory. To protect against spurious EEPROM writes, various mechanisms have been built-in. On power-up, the WREN bit is cleared; also, the Power-up Timer prevents EEPROM write.

The write initiate sequence and the WREN bit together, help prevent an accidental write during brown-out, power glitch or software malfunction.

TABLE 11-1: TIMER4/5 REGISTER MAP(1)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
TMR4	0114	Timer4 Register																uuuu uuuu uuuu uuuu
TMR5HLD	0116	Timer5 Holding Register (For 32-bit operations only)																uuuu uuuu uuuu uuuu
TMR5	0118	Timer5 Register																uuuu uuuu uuuu uuuu
PR4	011A	Period Register 4																1111 1111 1111 1111
PR5	011C	Period Register 5																1111 1111 1111 1111
T4CON	011E	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	T45	—	TCS	—	0000 0000 0000 0000
T5CON	0120	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	—	—	TCS	—	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'

Note 1: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

18.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART) MODULE

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046).

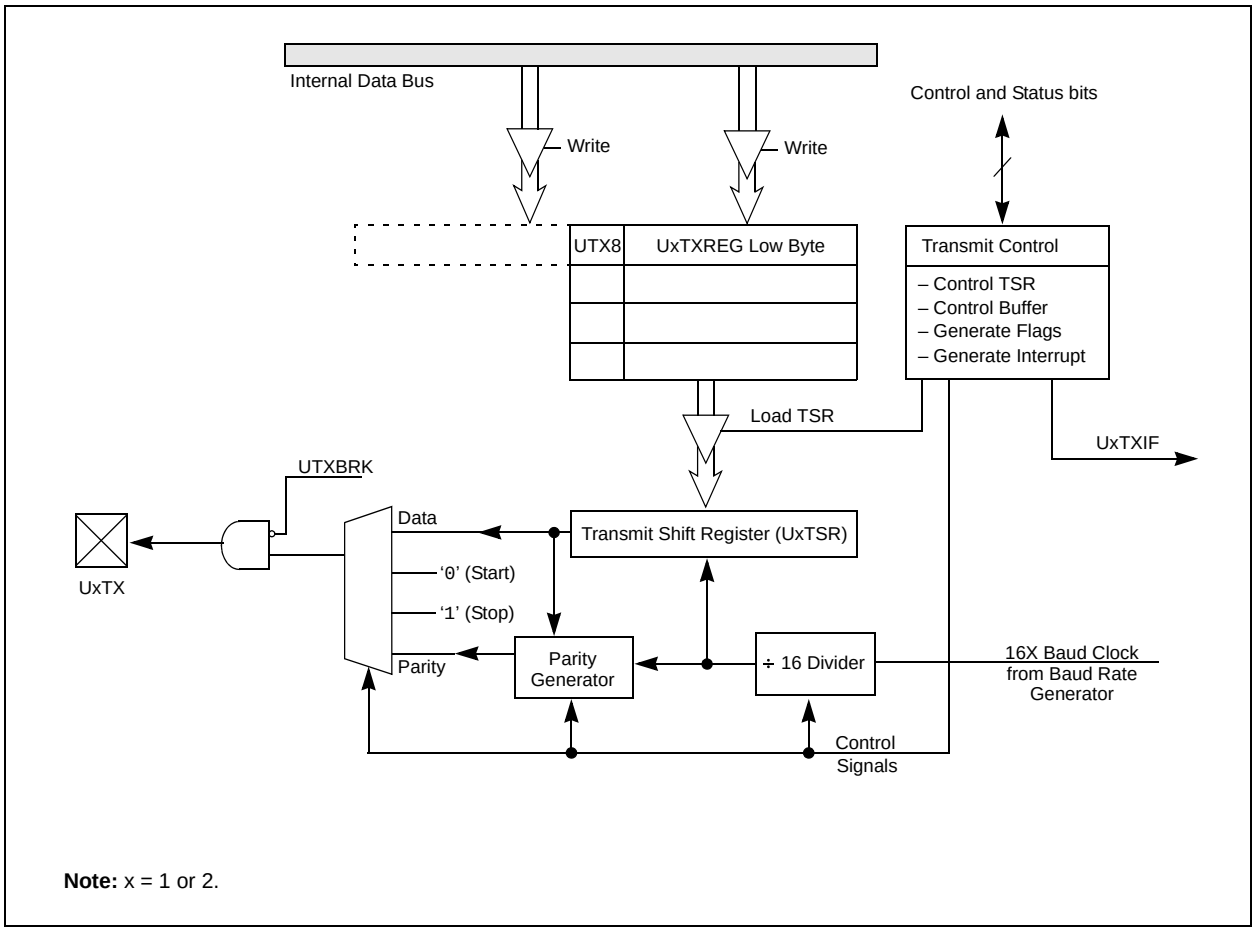
This section describes the Universal Asynchronous Receiver/Transmitter Communications module.

18.1 UART Module Overview

The key features of the UART module are:

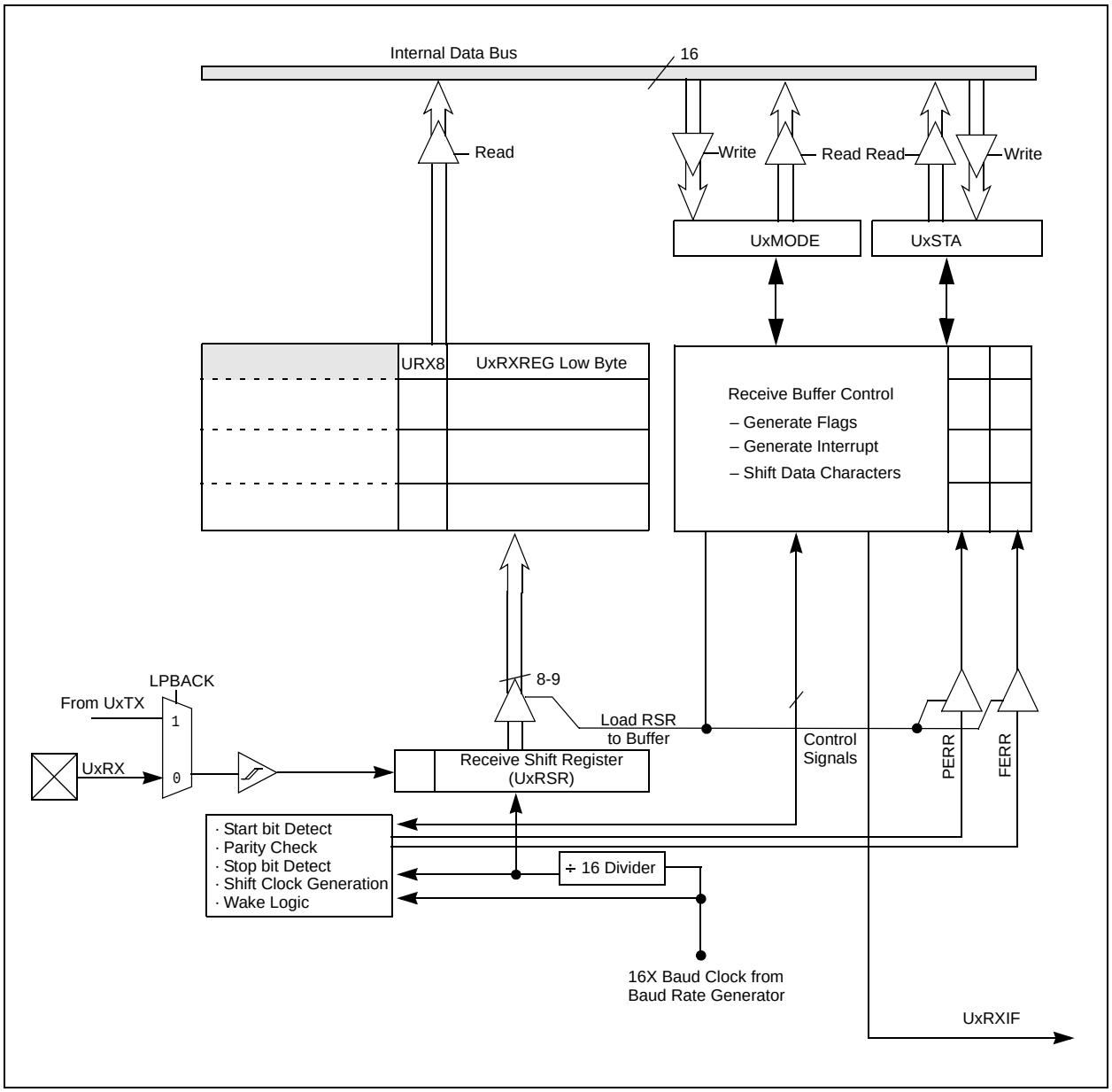
- Full-duplex, 8 or 9-bit data communication
- Even, Odd or No Parity options (for 8-bit data)
- One or two Stop bits
- Fully integrated Baud Rate Generator with 16-bit prescaler
- Baud rates range from 38 bps to 1.875 Mbps at a 30 MHz instruction rate
- 4-word deep transmit data buffer
- 4-word deep receive data buffer
- Parity, Framing and Buffer Overrun error detection
- Support for Interrupt only on Address Detect (9th bit = 1)
- Separate Transmit and Receive Interrupts
- Loopback mode for diagnostic support

FIGURE 18-1: UART TRANSMITTER BLOCK DIAGRAM



Note: x = 1 or 2.

FIGURE 18-2: UART RECEIVER BLOCK DIAGRAM



- Receive Error Interrupts

A receive error interrupt will be indicated by the ERRIF bit. This bit shows that an error condition occurred. The source of the error can be determined by checking the bits in the CAN Interrupt STATUS register, CiINTF.

- Invalid message received

If any type of error occurred during reception of the last message, an error will be indicated by the IVRIF bit.

- Receiver overrun

The RXnOVR bit indicates that an overrun condition occurred.

- Receiver warning

The RXWAR bit indicates that the Receive Error Counter (RERRCNT<7:0>) has reached the Warning limit of 96.

- Receiver error passive

The RXEP bit indicates that the Receive Error Counter has exceeded the Error Passive limit of 127 and the module has gone into Error Passive state.

19.5 Message Transmission

19.5.1 TRANSMIT BUFFERS

The CAN module has three transmit buffers. Each of the three buffers occupies 14 bytes of data. Eight of the bytes are the maximum 8 bytes of the transmitted message. Five bytes hold the standard and extended identifiers and other message arbitration information.

19.5.2 TRANSMIT MESSAGE PRIORITY

Transmit priority is a prioritization within each node of the pending transmittable messages. There are 4 levels of transmit priority. If TXPRI<1:0> (CiTXnCON<1:0>, where n = 0, 1 or 2 represents a particular transmit buffer) for a particular message buffer is set to '11', that buffer has the highest priority. If TXPRI<1:0> for a particular message buffer is set to '10' or '01', that buffer has an intermediate priority. If TXPRI<1:0> for a particular message buffer is '00', that buffer has the lowest priority.

19.5.3 TRANSMISSION SEQUENCE

To initiate transmission of the message, the TXREQ bit (CiTXnCON<3>) must be set. The CAN bus module resolves any timing conflicts between setting of the TXREQ bit and the Start of Frame (SOF), ensuring that if the priority was changed, it is resolved correctly before the SOF occurs. When TXREQ is set, the TXABT (CiTXnCON<6>), TXLARB (CiTXnCON<5>) and TXERR (CiTXnCON<4>) flag bits are automatically cleared.

Setting TXREQ bit simply flags a message buffer as enqueued for transmission. When the module detects an available bus, it begins transmitting the message which has been determined to have the highest priority.

If the transmission completes successfully on the first attempt, the TXREQ bit is cleared automatically and an interrupt is generated if TXIE was set.

If the message transmission fails, one of the error condition flags will be set and the TXREQ bit will remain set indicating that the message is still pending for transmission. If the message encountered an error condition during the transmission attempt, the TXERR bit will be set and the error condition may cause an interrupt. If the message loses arbitration during the transmission attempt, the TXLARB bit is set. No interrupt is generated to signal the loss of arbitration.

19.5.4 ABORTING MESSAGE TRANSMISSION

The system can also abort a message by clearing the TXREQ bit associated with each message buffer. Setting the ABAT bit (CiCTRL<12>) will request an abort of all pending messages. If the message has not yet started transmission, or if the message started but is interrupted by loss of arbitration or an error, the abort will be processed. The abort is indicated when the module sets the TXABT bit, and the TXnIF flag is not automatically set.

19.5.5 TRANSMISSION ERRORS

The CAN module will detect the following transmission errors:

- Acknowledge error
- Form error
- Bit error

These transmission errors will not necessarily generate an interrupt, but are indicated by the transmission error counter. However, each of these errors will cause the transmission error counter to be incremented by one. Once the value of the error counter exceeds the value of 96, the ERRIF (CiINTF<5>) and the TXWAR bit (CiINTF<10>) are set. Once the value of the error counter exceeds the value of 96, an interrupt is generated and the TXWAR bit in the Error Flag register is set.

21.2.6 LOW-POWER RC OSCILLATOR (LPRC)

The LPRC oscillator is a component of the Watchdog Timer (WDT) and oscillates at a nominal frequency of 512 kHz. The LPRC oscillator is the clock source for the Power-up Timer (PWRT) circuit, WDT and clock monitor circuits. It may also be used to provide a low frequency clock source option for applications where power consumption is critical, and timing accuracy is not required.

The LPRC oscillator is always enabled at a Power-on Reset, because it is the clock source for the PWRT. After the PWRT expires, the LPRC oscillator will remain ON if one of the following is TRUE:

- The Fail-Safe Clock Monitor is enabled
- The WDT is enabled
- The LPRC oscillator is selected as the system clock via the COSC<2:0> control bits in the OSCCON register

If one of the above conditions is not true, the LPRC will shut-off after the PWRT expires.

Note 1:	OSC2 pin function is determined by the Primary Oscillator mode selection (FPR<4:0>).
2:	Note that OSC1 pin cannot be used as an I/O pin, even if the secondary oscillator or an internal clock source is selected at all times.

21.2.7 FAIL-SAFE CLOCK MONITOR

The Fail-Safe Clock Monitor (FSCM) allows the device to continue to operate even in the event of an oscillator failure. The FSCM function is enabled by appropriately programming the FCKSM Configuration bits (Clock Switch and Monitor Selection bits) in the FOSC device Configuration register. If the FSCM function is enabled, the LPRC internal oscillator will run at all times (except during Sleep mode) and will not be subject to control by the SWDTEN bit.

In the event of an oscillator failure, the FSCM will generate a clock failure trap event and will switch the system clock over to the FRC oscillator. The user will then have the option to either attempt to restart the oscillator or execute a controlled shutdown. The user may decide to treat the trap as a warm Reset by simply loading the Reset address into the oscillator fail trap vector. In this event, the CF (Clock Fail) Status bit (OSCCON<3>) is also set whenever a clock failure is recognized.

In the event of a clock failure, the WDT is unaffected and continues to run on the LPRC clock.

If the oscillator has a very slow start-up time coming out of POR, BOR or Sleep, it is possible that the PWRT timer will expire before the oscillator has started. In such cases, the FSCM will be activated and the FSCM will initiate a clock failure trap, and the COSC<2:0> bits are loaded with FRC oscillator selection. This will effectively shut-off the original oscillator that was trying to start.

The user may detect this situation and restart the oscillator in the clock fail trap ISR.

Upon a clock failure detection, the FSCM module will initiate a clock switch to the FRC oscillator as follows:

1. The COSC bits (OSCCON<14:12>) are loaded with the FRC oscillator selection value.
2. CF bit is set (OSCCON<3>).
3. OSWEN control bit (OSCCON<0>) is cleared.

For the purpose of clock switching, the clock sources are sectioned into four groups:

- Primary
- Secondary
- Internal FRC
- Internal LPRC

The user can switch between these functional groups, but cannot switch between options within a group. If the primary group is selected, then the choice within the group is always determined by the FPR<4:0> Configuration bits.

The OSCCON register holds the control and Status bits related to clock switching.

- COSC<2:0>: Read-only Status bits always reflect the current oscillator group in effect.
- NOSC<2:0>: Control bits which are written to indicate the new oscillator group of choice.
  - On POR and BOR, COSC<2:0> and NOSC<2:0> are both loaded with the Configuration bit values FOS<2:0>.
- LOCK: The LOCK Status bit indicates a PLL lock.
- CF: Read-only Status bit indicating if a clock fail detect has occurred.
- OSWEN: Control bit changes from a '0' to a '1' when a clock transition sequence is initiated. Clearing the OSWEN control bit will abort a clock transition in progress (used for hang-up situations).

If Configuration bits FCKSM<1:0> = 1x, then the clock switching and Fail-Safe Clock Monitor functions are disabled. This is the default Configuration bit setting.

If clock switching is disabled, then the FOS<2:0> and FPR<4:0> bits directly control the oscillator selection and the COSC<2:0> bits do not control the clock selection. However, these bits will reflect the clock source selection.

Note:	The application should not attempt to switch to a clock of frequency lower than 100 kHz when the Fail-Safe Clock Monitor is enabled. If clock switching is performed, the device may generate an oscillator fail trap and switch to the fast RC oscillator.

FIGURE 21-3: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ TIED TO V_{DD})

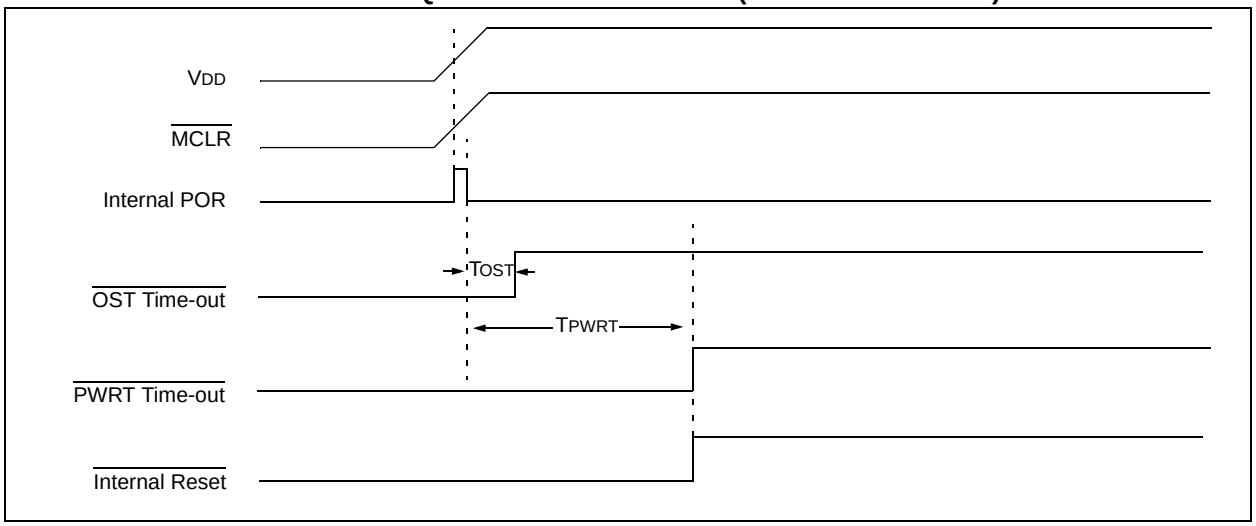


FIGURE 21-4: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ NOT TIED TO V_{DD}): CASE 1

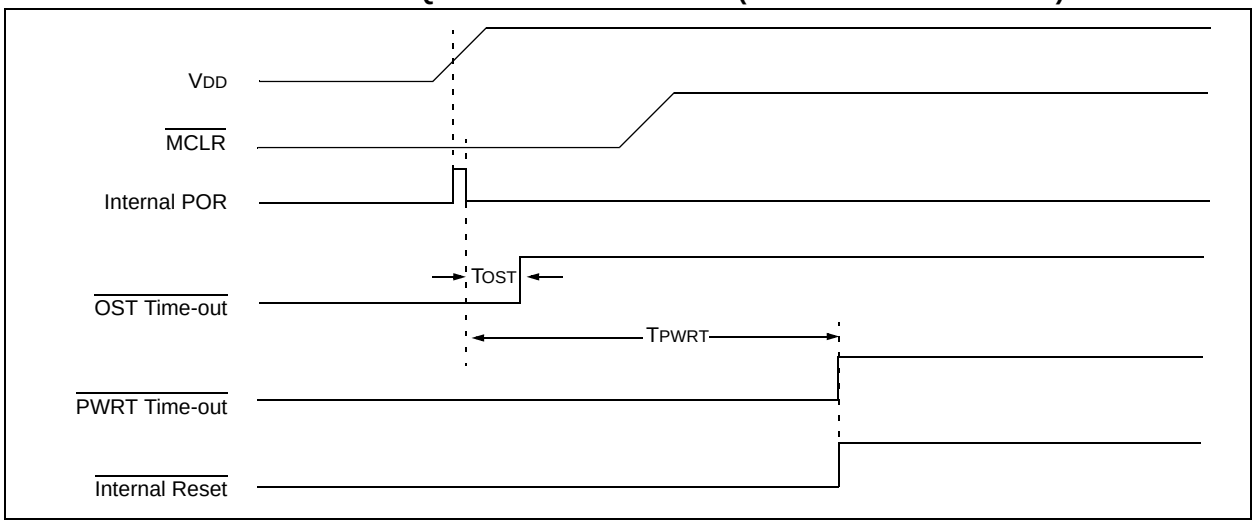
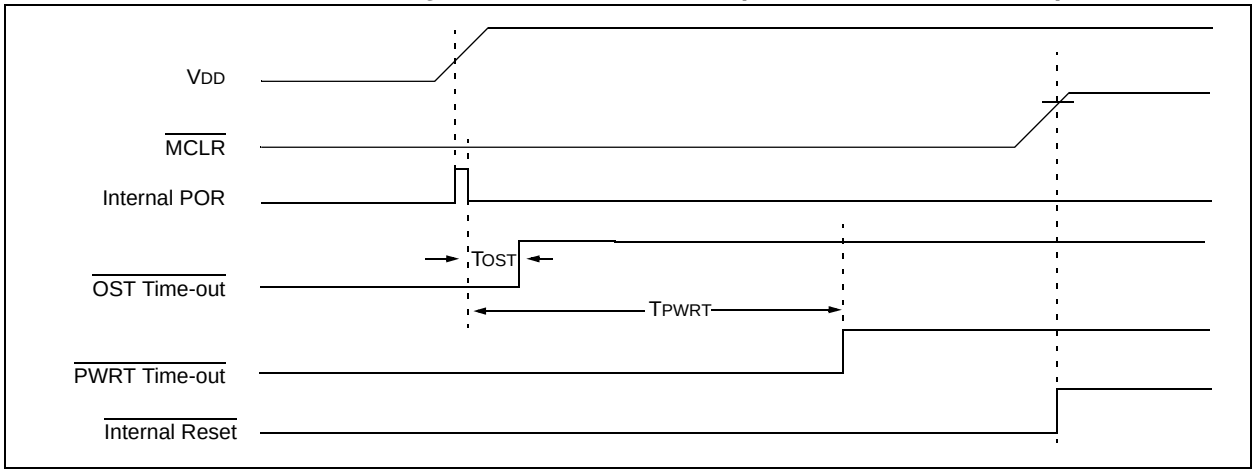


FIGURE 21-5: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ NOT TIED TO V_{DD}): CASE 2



23.2 MPLAB C Compilers for Various Device Families

The MPLAB C Compiler code development systems are complete ANSI C compilers for Microchip's PIC18, PIC24 and PIC32 families of microcontrollers and the dsPIC30 and dsPIC33 families of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

23.3 HI-TECH C for Various Device Families

The HI-TECH C Compiler code development systems are complete ANSI C compilers for Microchip's PIC family of microcontrollers and the dsPIC family of digital signal controllers. These compilers provide powerful integration capabilities, omniscient code generation and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

The compilers include a macro assembler, linker, preprocessor, and one-step driver, and can run on multiple platforms.

23.4 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

23.5 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

23.6 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC devices. MPLAB C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command line interface
- Rich directive set
- Flexible macro language
- MPLAB IDE compatibility

23.7 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC® DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

23.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC® Flash MCUs and dsPIC® Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

23.9 MPLAB ICD 3 In-Circuit Debugger System

MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost effective high-speed hardware debugger/programmer for Microchip Flash Digital Signal Controller (DSC) and microcontroller (MCU) devices. It debugs and programs PIC® Flash microcontrollers and dsPIC® DSCs with the powerful, yet easy-to-use graphical user interface of MPLAB Integrated Development Environment (IDE).

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

23.10 PICkit 3 In-Circuit Debugger/ Programmer and PICkit 3 Debug Express

The MPLAB PICkit 3 allows debugging and programming of PIC® and dsPIC® Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB Integrated Development Environment (IDE). The MPLAB PICkit 3 is connected to the design engineer's PC using a full speed USB interface and can be connected to the target via an Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the reset line to implement in-circuit debugging and In-Circuit Serial Programming™.

The PICkit 3 Debug Express include the PICkit 3, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

TABLE 24-5: DC TEMPERATURE AND VOLTAGE SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
Operating Voltage(2)							
DC10	VDD	**Supply Voltage**	2.5	—	5.5	V	Industrial temperature
DC11	VDD	**Supply Voltage**	3.0	—	5.5	V	Extended temperature
DC12	VDR	**RAM Data Retention Voltage(3)**	1.75	—	—	V	—
DC16	VPOR	**VDD Start Voltage** to ensure internal Power-on Reset signal	—	VSS	—	V	—
DC17	SVDD	**VDD Rise Rate** to ensure internal Power-on Reset signal	0.05	—	—	V/ms	0-5V in 0.1 sec 0-3V in 60 ms

Note 1: Data in “Typ” column is at 5V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: These parameters are characterized but not tested in manufacturing.

3: This is the limit to which VDD can be lowered without losing RAM data.

TABLE 24-8: DC CHARACTERISTICS: POWER-DOWN CURRENT (I_{PD})

DC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Conditions**		
Power-Down Current (I_{PD})(2)						
DC60a	0.2	—	µA	25°C	3.3V	Base Power-Down Current(3)
DC60b	1.2	40	µA	85°C		
DC60c	12	65	µA	125°C		
DC60e	0.4	—	µA	25°C	5V	
DC60f	1.7	55	µA	85°C		
DC60g	15	90	µA	125°C		
DC61a	9	15	µA	25°C	3.3V	Watchdog Timer Current: ΔI_{WDT}(3)
DC61b	9	15	µA	85°C		
DC61c	9	15	µA	125°C		
DC61e	18	30	µA	25°C	5V	
DC61f	17	30	µA	85°C		
DC61g	16	30	µA	125°C		
DC62a	4	10	µA	25°C	3.3V	Timer1 w/32 kHz Crystal: ΔI_{TI32}(3)
DC62b	5	10	µA	85°C		
DC62c	4	10	µA	125°C		
DC62e	4	15	µA	25°C	5V	
DC62f	6	15	µA	85°C		
DC62g	5	15	µA	125°C		
DC63a	29	52	µA	25°C	3.3V	BOR On: ΔI_{BOR}(3)
DC63b	32	52	µA	85°C		
DC63c	33	52	µA	125°C		
DC63e	34	60	µA	25°C	5V	
DC63f	39	60	µA	85°C		
DC63g	38	60	µA	125°C		

Note 1: Data in the "Typical" column is at 5V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Base I_{PD} is measured with all peripherals and clocks shut down. All I/Os are configured as inputs and pulled high. BOR, WDT, etc. are all switched off.

3: The Δ current is the additional current consumed when the module is enabled. This current should be added to the base I_{PD} current.